

## **General Description**

The WSP9926B is the highest performance trench N-ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WSP9926B meet the RoHS and Green Product requirement with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

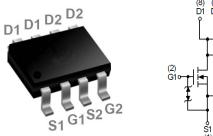
## **Product Summery**

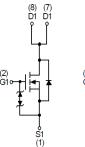
BVDSS	RDSON	ID
20V	17mΩ	8A

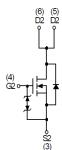
### **Applications**

- High Frequency Point-of-Load Synchronous
  Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- ESD:2KV

### **SOP-8 Pin Configuration**







### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	20	V	
$V_{GS}$	Gate-Source Voltage	±12	V	
I <sub>D</sub> @T <sub>A</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 4.5V <sup>1</sup>	8	Α	
I <sub>D</sub> @T <sub>A</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ 4.5V <sup>1</sup>	6.5	Α	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	32	Α	
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>3</sup>	2	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		$^{\circ}$	
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	$^{\circ}$	

### **Thermal Data**

Symbol	Parameter Typ.		Max.	Unit	
$R_{ heta JA}$	Thermal Resistance Junction-ambient <sup>1</sup>		62.5	°C/W	
R <sub>eJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		10	°C/W	



### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =250uA	20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.022		V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =8A		17	26	mΩ
		V <sub>GS</sub> =2.5V , I <sub>D</sub> =6.8A		12	34	
$V_{GS(th)}$	Gate Threshold Voltage	\/ -\/   -250uA	0.5	0.7	1.1	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$-V_{GS}=V_{DS}$ , $I_D=250uA$		-2.33		mV/℃
	Drain Source Leakage Current	V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃			1	· uA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 12V$ , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =5A		25		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		4.5		Ω
$Q_{g}$	Total Gate Charge (4.5V)			11.3	17	
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =10V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =8A		2.7		nC
$Q_gd$	Gate-Drain Charge			3.5		
T <sub>d(on)</sub>	Turn-On Delay Time			5.2	9.5	
Tr	Rise Time	$V_{DD}$ =10V , $V_{GS}$ =4.5V , $R_{G}$ =6 $\Omega$ $I_{D}$ =5A , $R_{L}$ =10 $\Omega$	13.2	24	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time		40.5	73		
T <sub>f</sub>	Fall Time			21.5	39	
C <sub>iss</sub>	Input Capacitance			650		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =10V , V <sub>GS</sub> =0V , f=1MHz		140		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			135		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,4</sup>	// =// =0\/ Force Current			1	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			32	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.3	V
t <sub>rr</sub>	Reverse Recovery Time			19.2		nS
Q <sub>rr</sub>	Reverse Recovery Charge	lF=8A,dI/dt=100A/μs,T <sub>J</sub> =25℃		4.6		nC

#### Note:

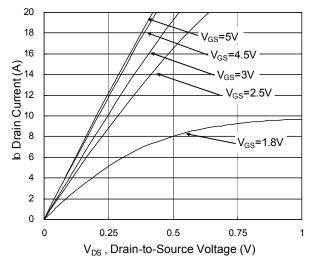
<sup>1.</sup> The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

<sup>2.</sup>The data tested by pulsed , pulse width  $\le 300 us$  , duty cycle  $\le 2\%$  3.The power dissipation is limited by 150  $^\circ\!\!\!\!\!\!\mathrm{C}$  junction temperature

 $<sup>\</sup>textbf{4.The data is theoretically the same as } I_{D} \text{ and } I_{DM} \text{ , in real applications , should be limited by total power dissipation.}$ 



# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

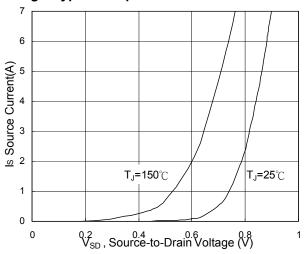


Fig.3 Forward Characteristics Of Reverse

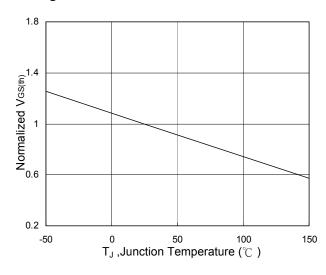


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

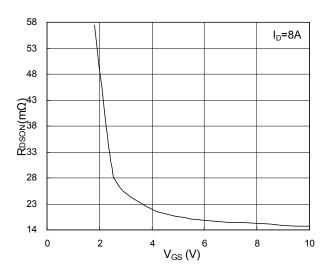


Fig.2 On-Resistance vs. Gate-Source

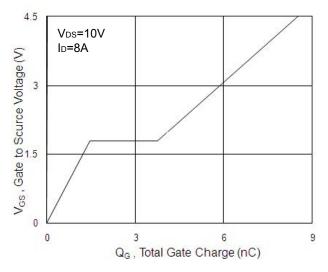


Fig.4 Gate-Charge Characteristics

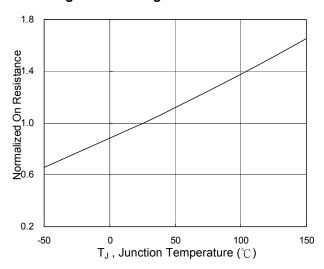
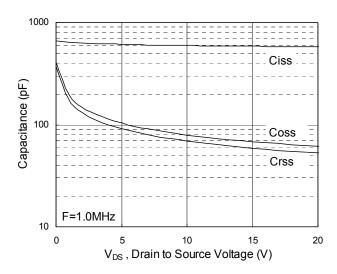


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>





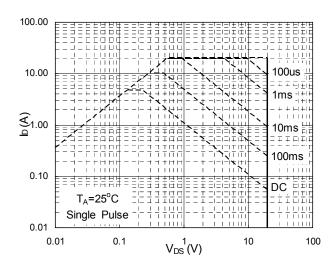


Fig.7 Capacitance

Fig.8 Safe Operating Area

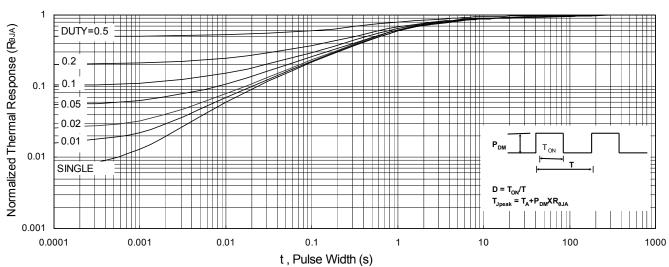


Fig.9 Normalized Maximum Transient Thermal Impedance

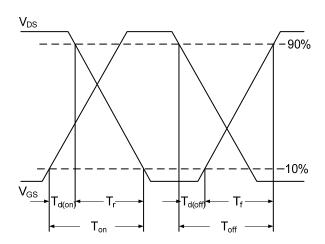


Fig.10 Switching Time Waveform

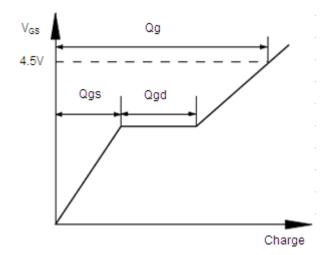


Fig.11 Gate Charge Waveform



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